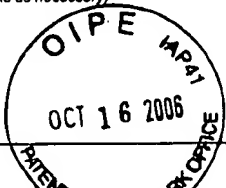


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		Application Number	09/382,929
		Filing Date	August 25, 1999
		First Named Inventor	Farrar, Paul
		Group Art Unit	2822
		Examiner Name	Graybill, David
Sheet 1 of 3		Attorney Docket No: 303.603US1	

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